
maXTouch 2911-node Touchscreen Controller Product Brief

Description

The mXT2912TD-ATKD/mXT2912TD-ABKD 1.0 uses a unique charge-transfer acquisition engine to implement Microchip's patented capacitive sensing method. Coupled with a state-of-the-art CPU, the entire touchscreen sensing solution can measure, classify and track a number of individual finger touches with a high degree of accuracy in the shortest response time.

Automotive Applications

- AEC-Q100 Qualified
- CISPR 25 compliant

Knob-on-Display™ Technology

- Detect and report the detent (click position) of specific capacitive mechanical rotary encoders (knobs) mounted on the touch panel
- Support for up to 4 Knob instances with different size and number of detents (64 detents maximum)
- Position and size of each knob is individually configurable. No specific touch pattern required
- Report absolute or relative detent position as well as the direction of rotation
- Configurable suppression area around the knob to suppress accidental touches from fingers holding the knob
- Optional push/release function
- Design guidance, tools and other services available from Microchip

maXTouch® Adaptive Sensing Technology

- Up to 41 X (transmit) lines and 71 Y (receive) lines for use by a touchscreen and/or 2 key arrays
- A maximum of 2911 nodes can be allocated to the touch sensor
- Touchscreen size of 19.25 inches (16:9 aspect ratio), assuming a sensor electrode pitch of 6 mm. The achievable touchscreen size depends on the knob requirements
- Multiple touch support with up to 16 concurrent touches tracked in real time depending on the number of knobs implemented

Keys

- Up to 32 nodes can be allocated as mutual capacitance sensor keys in addition to the touchscreen, defined as 2 key arrays (subject to availability of X and Y lines and other configurations)

- Adjacent Key Suppression (AKS) technology is supported for false key touch prevention

Touch Sensor Technology

- Discrete/out-cell support including glass and PET film-based sensors
- On-cell/touch-on display support including TFT, LCD (ITPS, IPS) and OLED
- Synchronization with display refresh timing capability
- Support for standard (for example, Diamond) and proprietary sensor patterns (review of designs by Microchip or a Microchip-qualified touch sensor module partner is recommended)

Front Panel Material and Design

- Works with PET or glass (dependent on sensor size, touch size, configuration, stack-up, and dimension and number of detents of the knob)
- KoD™ Knob Designer tool provides guidance on material and thickness
- Configuration and stack-up to be approved by Microchip or a Microchip-qualified touch sensor module partner
- Support for non-rectangular sensor designs (for example, circular, rounded or with cutouts)

Touch Performance

- Moisture/Water Compensation
 - No false touch with condensation
- P2P mutual capacitance measurements supported for extra sensitive multi-touch sensing
- Noise suppression technology to combat ambient and power-line noise
 - Up to 240 V_{PP} between 1 Hz and 1 kHz sinusoidal waveform (no touches)
 - Up to 20 V_{PP} between 1 kHz and 1 MHz sinusoidal waveform

- Burst Frequency
 - Flexible and dynamic Tx burst frequency selection to reduce EMC disturbance
 - Controlled Tx burst frequency drift over process and temperature range
- Scan Speed
 - Typical report rate for 10 touches \geq 100 Hz (subject to configuration)
 - Initial touch latency <20 ms for first touch from idle (subject to configuration)
 - Microchip Knob-on-Display rotation speed >120 rpm
 - Configurable for power and speed optimization
- Touch panel/knob failure detection
 - Automatic touch sensor diagnostics during run time to support the implementation of safety critical features
 - Diagnostics reported using dedicated output pin or by standard Object Protocol messages
 - Presence of knob detected
 - Configurable test limits

Enhanced Algorithms

- Dedicated drift calibration algorithm for the knob locations
- Lens bending algorithms to remove display noise
- Touch suppression algorithms to remove unintentional large touches
- Palm Recovery Algorithm for quick restoration to normal state

Data Store

- 60-byte CRC-checksummed data area for use as a run-time Product Data Store Area
- Up to 64 bytes of user's custom data (not CRC checksummed)

Power Saving

- Programmable timeout for automatic transition from Active to Idle state
- Pipelined analog sensing detection and digital processing to optimize system power efficiency

Application Interfaces

- Client interface for main communication with the device. Can be one of:
 - I²C interface, with support for Standard mode (up to 100 kHz), Fast mode (up to 400 kHz), Fast-mode Plus (up to 1 MHz)
 - SPI interface (up to 8 MHz)
- Interrupt to indicate when a message is available
- Additional SPI Debug Interface to read the raw data for tuning and debugging purposes

Power Supply

- Digital (Vdd) 3.3V nominal
- Digital I/O (VddIO) 3.3V nominal
- Analog (AVdd) 3.3V nominal
- High voltage external X line drive (XVdd) up to 8.5V

Package

- 176-lead LQFP 24 x 24 x 1.4 mm, 0.5 mm pitch

Operating Temperature

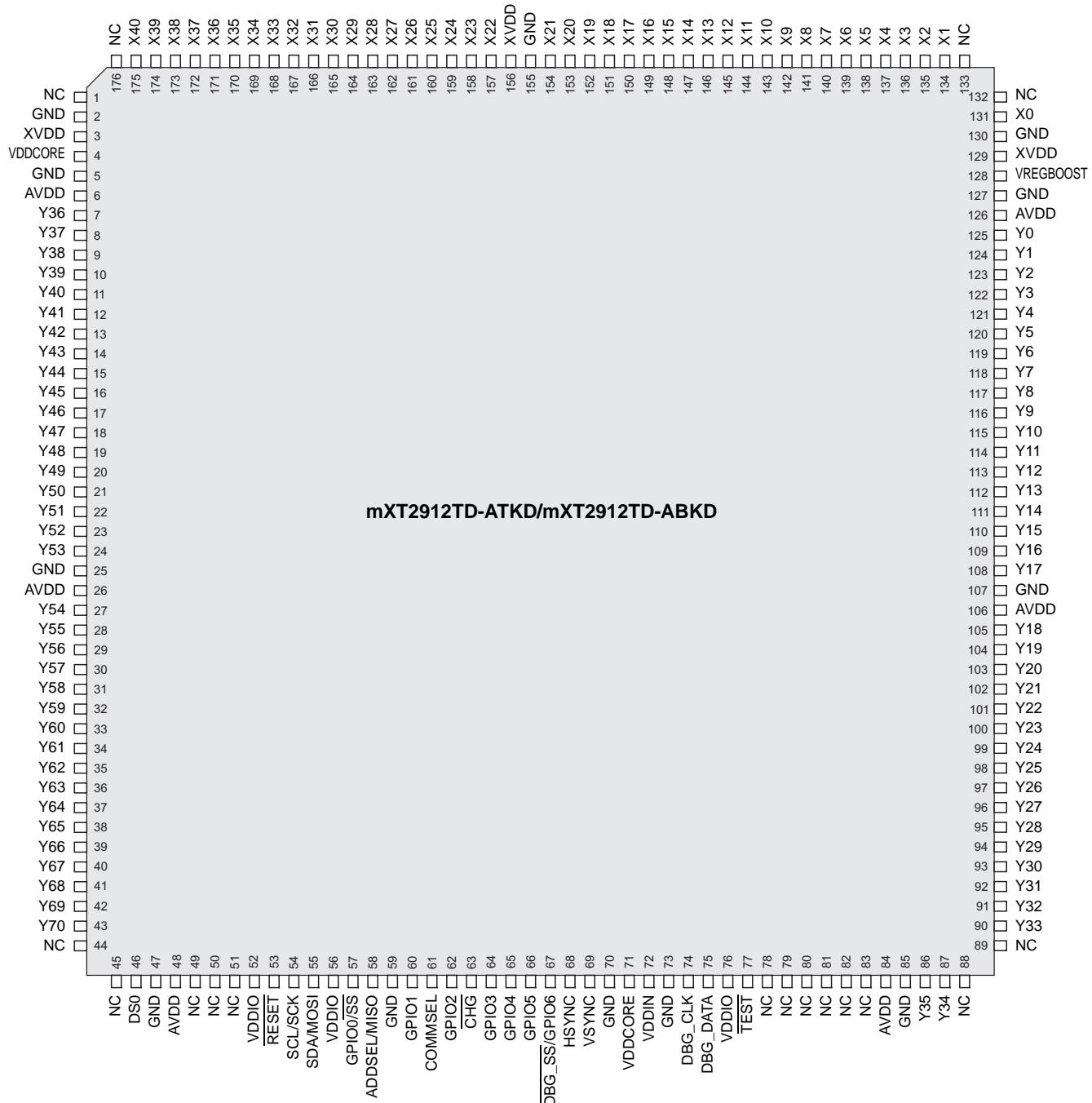
- ATMXT2912TD-ATKD: -40°C to +85°C (Grade 3)
- ATMXT2912TD-ABKD: -40°C to +105°C (Grade 2)

Design Services

- Review of device configuration, stack-up and sensor patterns
- Specific design and tuning tools available as maXTouch Studio plug-ins

PIN CONFIGURATION

176-lead LQFP

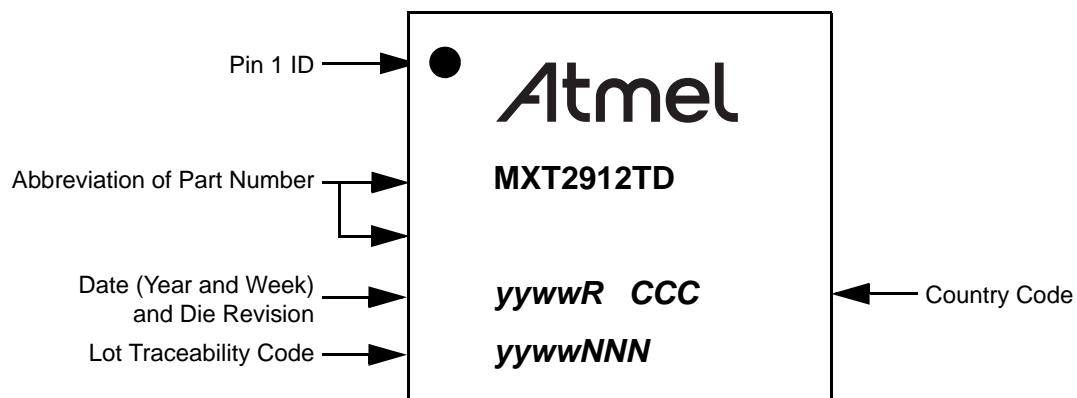


Top view

1.0 PACKAGING INFORMATION

1.1 Package Marking Information

1.1.1 176-LEAD LQFP



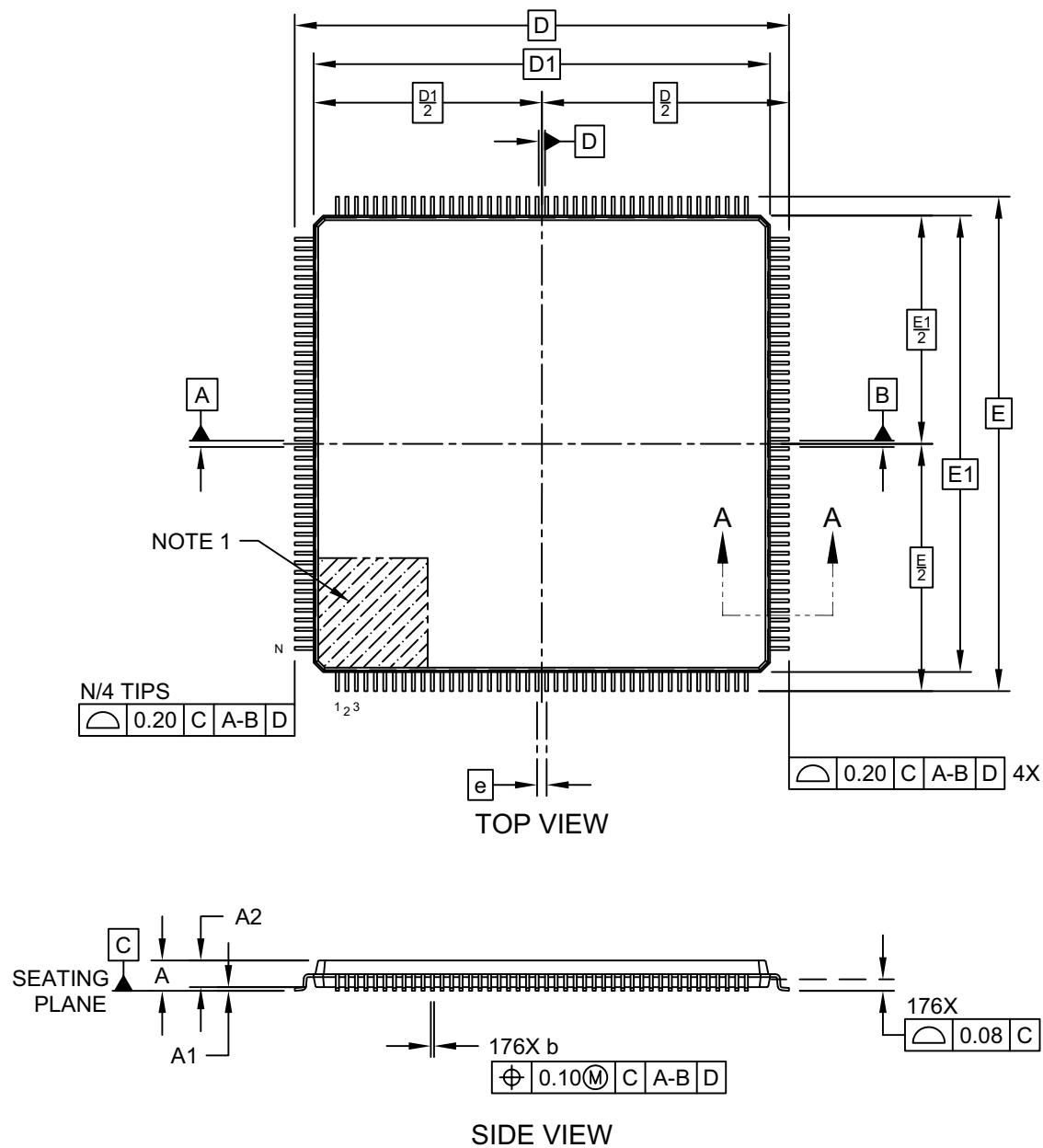
1.1.2 ORDERABLE PART NUMBERS

The product identification system for maXTouch devices is described in ["Product Identification System" on page 9](#). That section also lists example part numbers for the device.

1.2 Package Details

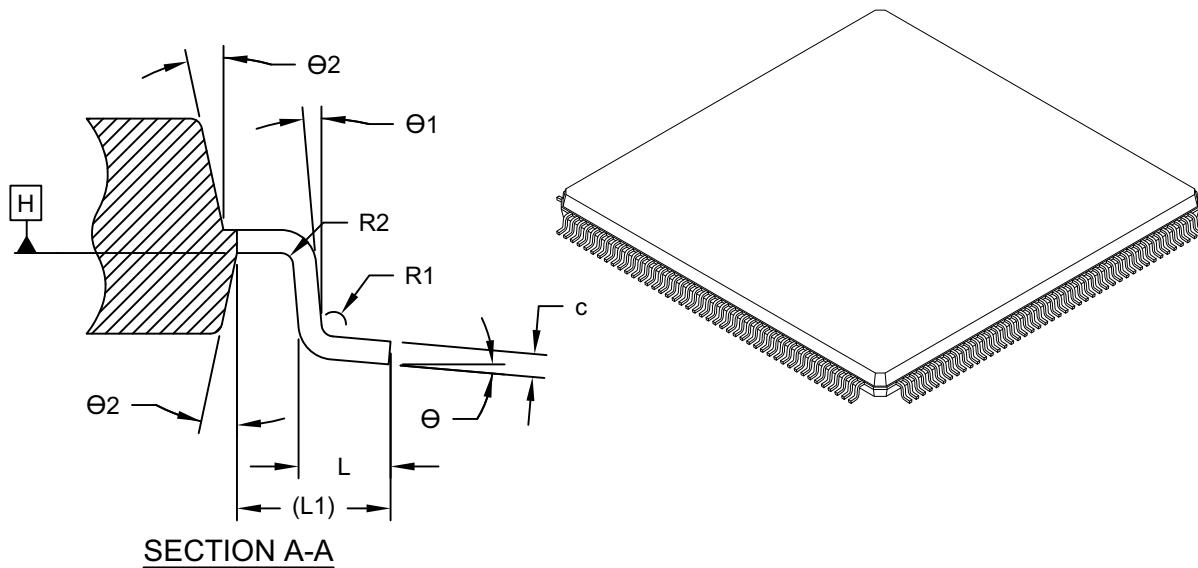
176-Lead Plastic Quad Flatpack (2VB) - 24x24x1.4 mm Body [LQFP] Atmel Legacy Global Package Code AGR

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



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Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



Dimension Limits		MILLIMETERS		
		MIN	NOM	MAX
Number of Terminals	N		176	
Pitch	e		0.50 BSC	
Overall Height	A	-	-	1.60
Standoff	A1	0.05	-	0.15
Molded Package Thickness	A2	1.35	1.40	1.45
Overall Length	D		26.00 BSC	
Molded Package Length	D1		24.00 BSC	
Overall Width	E		26.00 BSC	
Molded Package Width	E1		24.00 BSC	
Terminal Width	b	0.17	0.22	0.27
Terminal Thickness	c	0.09	-	0.20
Terminal Length	L	0.45	0.60	0.75
Footprint	L1		1.00 REF	-
Lead Bend Radius	R	0.08	-	-
Lead Bend Radius	R2	0.08	-	0.20
Foot Angle	Θ	0°	3.5°	7°
Lead Angle	Θ1	0°	-	-
Terminal-to-Exposed-Pad	Θ2	11°	12°	13°

Notes:

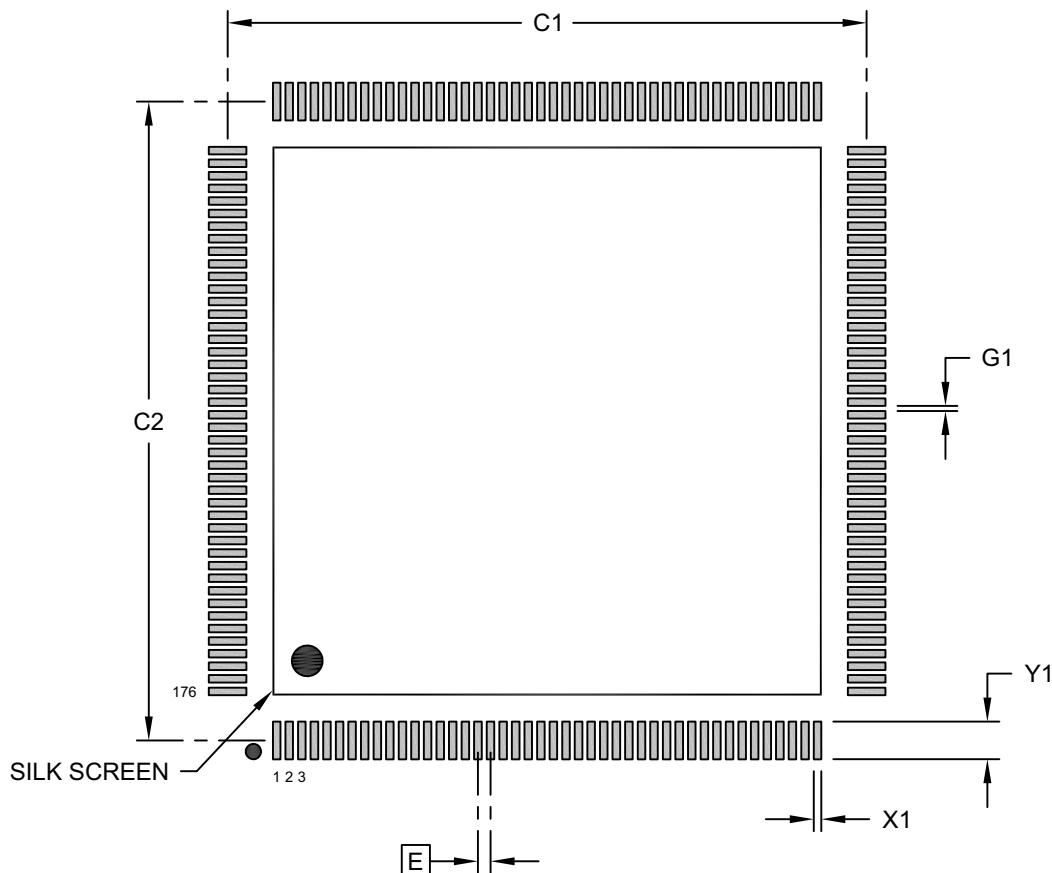
1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

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RECOMMENDED LAND PATTERN

Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Contact Pitch	E		0.50 BSC	
Contact Pad Spacing	C1		25.40	
Contact Pad Spacing	C2		25.40	
Contact Pad Width (X176)	X1			0.30
Contact Pad Length (X176)	Y1			1.50
Contact Pad to Center Pad (X172)	G1	0.20		

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing C04-23013 Rev A

APPENDIX A: REVISION HISTORY

Revision A (June 2022)

Initial edition for firmware revision 1.0.AA – Release

PRODUCT IDENTIFICATION SYSTEM

The table below gives details on the product identification system for maXTouch devices. See "[Orderable Part Numbers](#)" below for example part numbers for the mXT2912TD-ATKD/mXT2912TD-ABKD.

To order or obtain information, for example on pricing or delivery, refer to the factory or the listed sales office.

PART NO.	—XXX	[X]	[X]	[XXX]
Device	Package	Temperature Range	Tape and Reel Option	Pattern
Device:	Base device name			
Package:	A	=	QFP (Plastic Quad Flatpack)	
	AM	=	VQFN (Plastic Very Thin Quad Flat No Lead)	
Temperature Range:	T	=	−40°C to +85°C (Grade 3)	
	B	=	−40°C to +105°C (Grade 2)	
Tape and Reel Option:	<i>Blank</i>	=	Standard Packaging (Tube or Tray)	
	R	=	Tape and Reel ⁽¹⁾	
Pattern:	Extension, QTP, SQTP, Code or Special Requirements (Blank Otherwise)			
Note 1: Tape and Reel identifier only appears in the catalog part number description. This identifier is used for ordering purposes and is not printed on the device package. See " Orderable Part Numbers " below or check with your Microchip Sales Office for package availability with the Tape and Reel option.				

Orderable Part Numbers

Orderable Part Number	Firmware Revision	Description
ATMXT2912TD-ATKDVAO (Supplied in trays)	1.0.AA	176-lead LQFP 24 × 24 × 1.4 mm, RoHS compliant Operating temperature range −40°C to +85°C (Grade 3)
ATMXT2912TD-ATRKDVAO (Supplied in tape and reel)		
ATMXT2912TD-ABKDVAO (Supplied in trays)	1.0.AA	176-lead LQFP 24 × 24 × 1.4 mm, RoHS compliant Operating temperature range −40°C to +105°C (Grade 2)
ATMXT2912TD-ABRKDVAO (Supplied in tape and reel)		

mXT2912TD-ATKD/mXT2912TD-ABKD 1.0

NOTES:

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